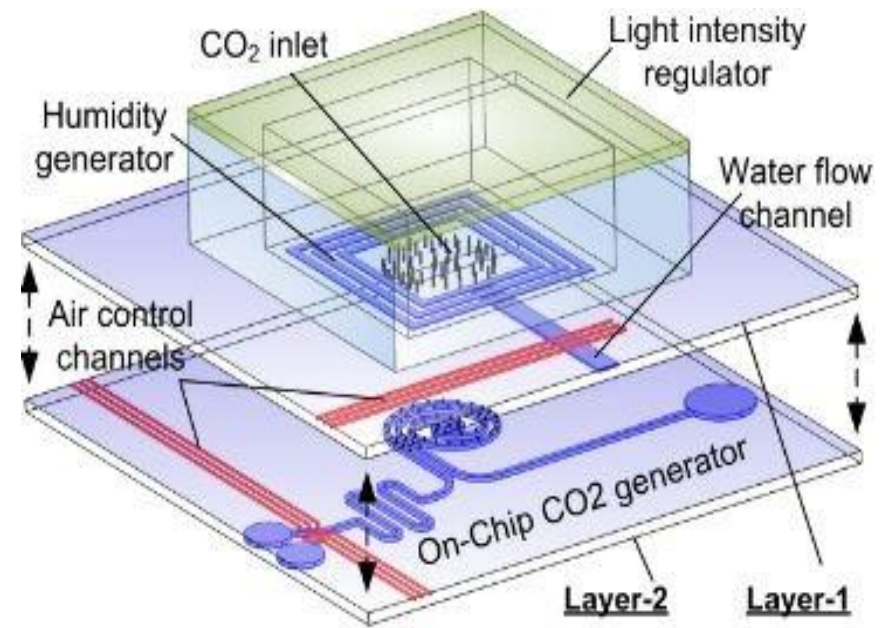


Environmental Control for a Chip Scale Laboratory

Abstract

The purpose of the chip-scale laboratory is to offer numerous individual seedling chambers that each house a single seed. The advantage is that each chamber can have a uniquely specified set of environmental conditions such as temperature, humidity and CO₂ levels.



Problem Statement

Develop a system capable of controlling humidity in multiple seedling chambers by detecting deviant humidity levels and pumping amounts of water to correct the humidity level.

Objectives

- Fabricate a 2-layer channel system capable of delivering small amounts of water
- Integrate sensor, solenoid and chamber systems into system capable of controlling humidity
- Implement a sensor array that can be expanded to facilitate up to 128 sensors.
- Using Verilog, develop a solenoid control program capable of 7-bit addressing and peristaltic pump action

COMPONENT OVERVIEW

SHT11X Humidity/Temperature Sensor:

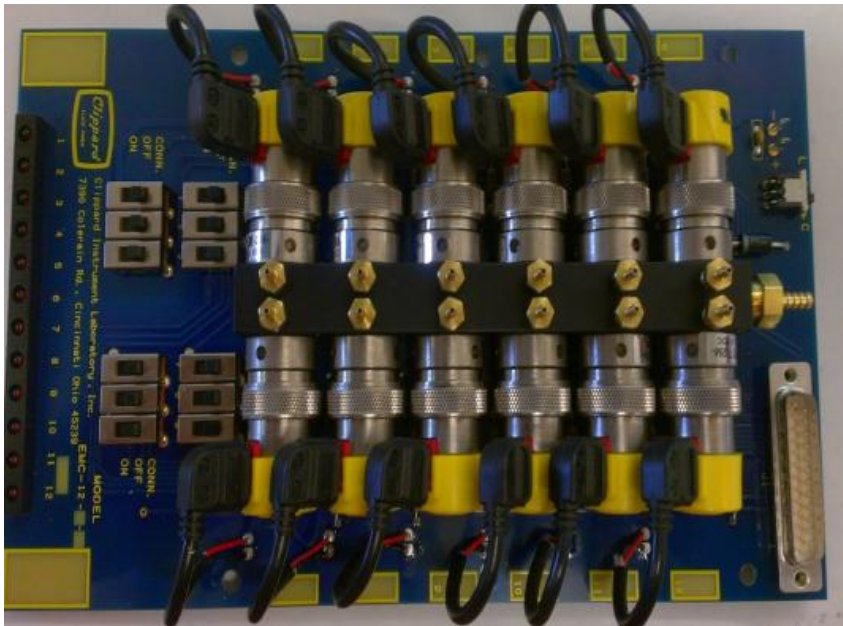
Range from -40 to 115 C
and 0-100% RH

Analog and Digital out
configurable

Very compact design

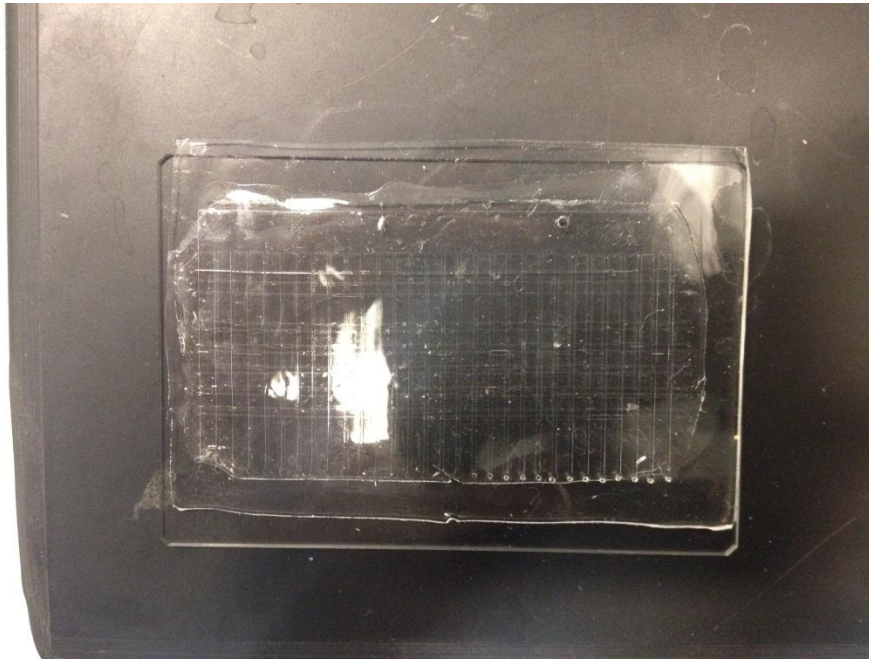


EMC-12-06-20 Solenoid Manifold:



12 Mounted Solenoids
Can deliver up to 100PSI
5-10ms response time
Low power
consumption(6V 0.4mA
Normally off)

Channel Overlay System:



Allows for individual chambers to be selected for humidity control
Facilitates peristaltic pumping through compression/decompression of three air chambers

System Description

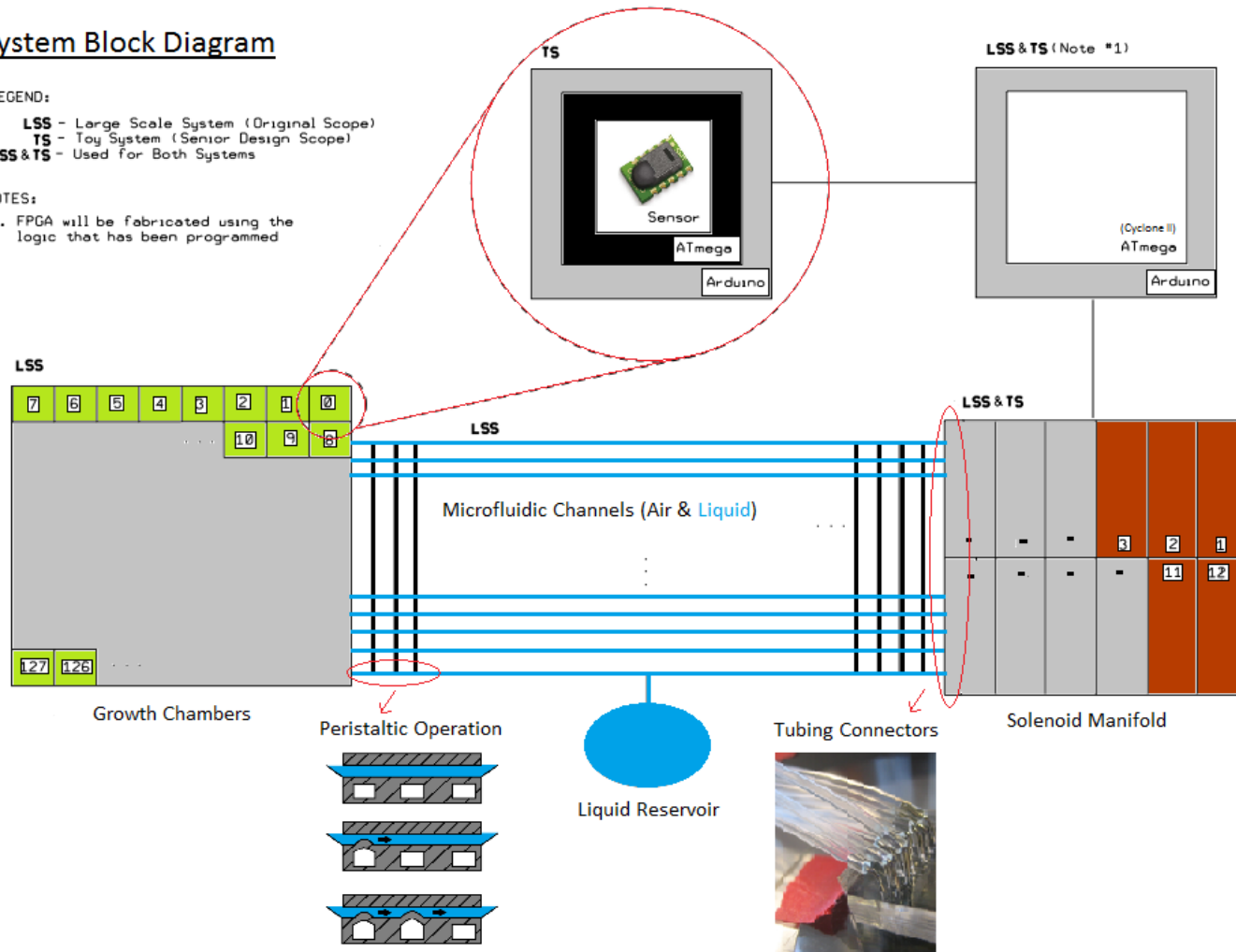
System Block Diagram

LEGEND:

- LSS** - Large Scale System (Original Scope)
- TS** - Toy System (Senior Design Scope)
- LSS & TS** - Used for Both Systems

NOTES:

1. FPGA will be fabricated using the logic that has been programmed

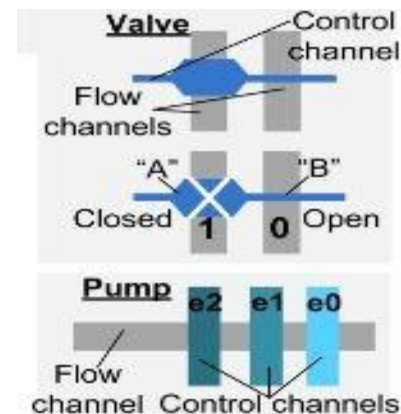
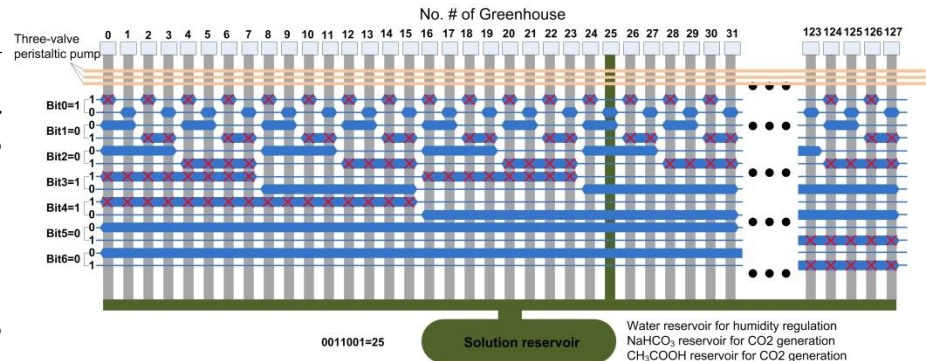


System Description

- Sensor detects humidity level.
- The output read is compared to preset conditions for chamber.
- The mismatch that's found is corrected by pumping liquid into specific chamber.
- When output matches, next chamber is addressed.

System Description

- Addresses individual chambers by applying air pressure
- Air pressure inflates weakend areas of material causing them to balloon, pinching off the water lines



Setup and Testing Methods

Sensor Array

- Master slave operation – Arduino
- Place in different environment & observe output

Solenoid Manifold

- 25 pin connector – Altera Cyclone II FPGA, Power Supply
- Testbench - Cadence

Setup and Testing Methods

Channel Overlay System

- First & Second layer are fabricated.
- Perform stress tests on material to verify proper layer bonding.

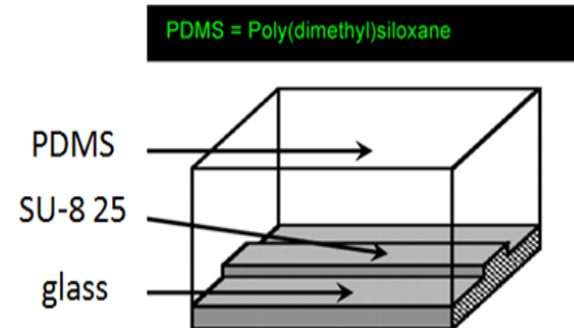
Small Scale System

- “1/8” tubing & “1/16” tubing connections, Arduino and Altera connections.
- TS system testing do not use the channels.

Problems Encountered

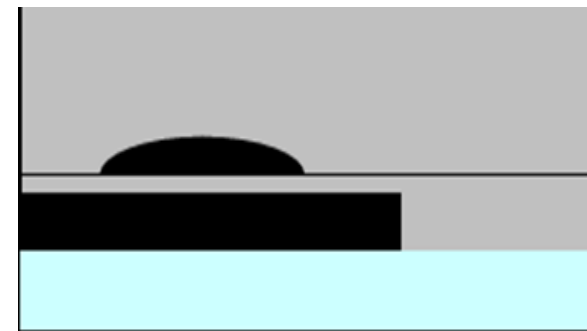
Fluid Delivery Channels

- Achieving correct thickness between layers of material
- Maintaining the strength of bond between layers to prevent rupture of channels



Solenoid Manifold System

- Interfacing sensor output with CycloneII in an easily readable way
- Importing code to CycloneII can cause unexpected errors where there were none in simulation



Problems Encountered

Temperature/Humidity Sensors

- a. Presenting sensor output in such a way that is both easily readable and can be expanded to 128 data paths easily
- b. Creating a multiple sensor package when originally, one was required

Management/Project Scope

- a. Scope of project changed multiple times
- b. Last minute additions to project
- c. Accepting changes as nature of project work/employment

Questions?